

To our customers,

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## Old Company Name in Catalogs and Other Documents

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Renesas Electronics website: <http://www.renesas.com>

April 1<sup>st</sup>, 2010  
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (<http://www.renesas.com>)

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Not recommended  
for new design

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To all our customers

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Renesas Technology Home Page: <http://www.renesas.com>

Renesas Technology Corp.  
Customer Support Dept.  
April 1, 2003

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# 2SJ576

## Silicon P Channel MOS FET High Speed Switching

# RENESAS

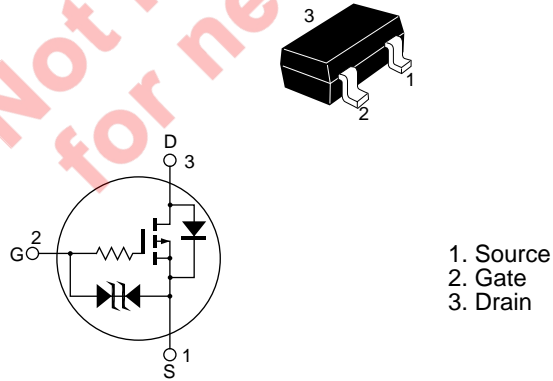
ADE-208-741B (Z)  
3rd.Edition.  
June 1999

### Features

- Low on-resistance  
 $R_{DS} = 2.8 \Omega$  typ. ( $V_{GS} = -10 \text{ V}$ ,  $I_D = -50 \text{ mA}$ )  
 $R_{DS} = 5.7 \Omega$  typ. ( $V_{GS} = -4 \text{ V}$ ,  $I_D = -50 \text{ mA}$ )
- 4 V gate drive device.
- Small package (CMPAK)

### Outline

CMPAK



## Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings	Unit
Drain to source voltage	$V_{DSS}$	-30	V
Gate to source voltage	$V_{GSS}$	±20	V
Drain current	$I_D$	-100	mA
Drain peak current	$I_{D(pulse)}$ <sup>Note 1</sup>	-400	mA
Body-drain diode reverse drain current	$I_{DR}$	-100	mA
Channel dissipation	Pch <sup>Note 2</sup>	300	mW
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Note: 1. PW ≤ 10 μs, duty cycle ≤ 1%

2. Value on the alumina ceramic board (12.5x20x0.7 mm)

## Electrical Characteristics (Ta = 25°C)

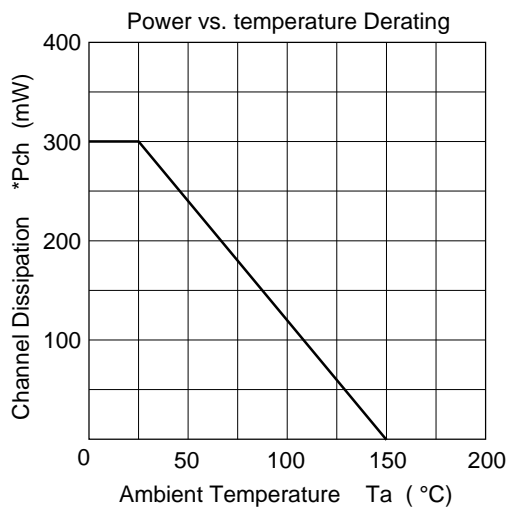
Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	-30	—	—	V	$I_D = -100 \mu A, V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	±20	—	—	V	$I_G = \pm 100 \mu A, V_{DS} = 0$
Gate to source leak current	$I_{GSS}$	—	—	±5	μA	$V_{GS} = \pm 16 V, V_{DS} = 0$
Zero gate voltage drain current	$I_{DSS}$	—	—	-1	μA	$V_{DS} = -30 V, V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	-1.3	—	-2.3	V	$I_D = -10 \mu A, V_{DS} = -5 V$
Static drain to source on state resistance	$R_{DS(on)}$	—	2.8	3.3	Ω	$I_D = -50 mA, V_{GS} = -10 V$ <sup>Note 3</sup>
	$R_{DS(on)}$	—	5.7	7.9	Ω	$I_D = -50 mA, V_{GS} = -4 V$ <sup>Note 3</sup>
Forward transfer admittance	$ y_{fs} $	68	105	—	mS	$I_D = -50 mA, V_{DS} = -10 V$ <sup>Note 3</sup>
Input capacitance	Ciss	—	25	—	pF	$V_{DS} = -10 V$
Output capacitance	Coss	—	20	—	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	—	8	—	pF	f = 1 MHz
Turn-on delay time	$t_{d(on)}$	—	10	—	ns	$I_D = -50 mA, V_{GS} = -10 V$
Rise time	$t_r$	—	15	—	ns	$R_L = 200 \Omega$
Turn-off delay time	$t_{d(off)}$	—	40	—	ns	
Fall time	$t_f$	—	45	—	ns	

Note: 3. Pulse test

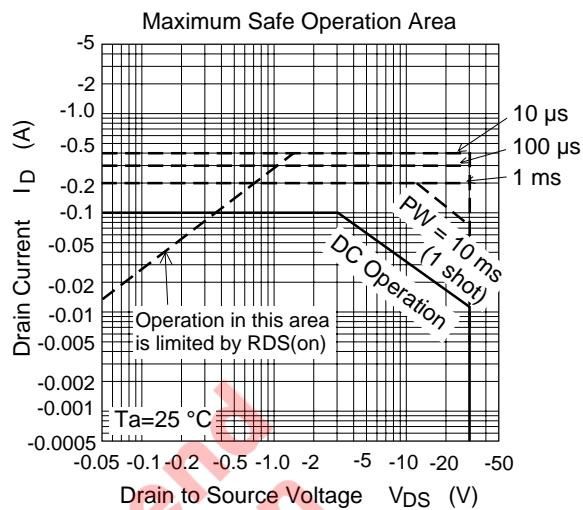
4. Marking is AP

See characteristics curves of 2SJ576

## Main Characteristics



\*Value on the alumina ceramic board.(12.5x20x0.7mm)



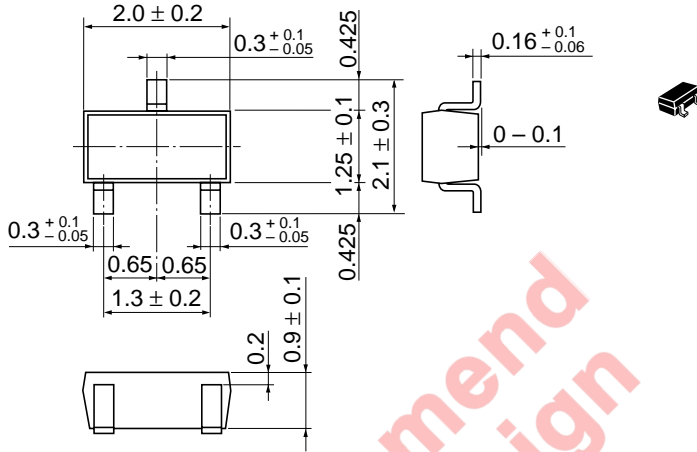
Value on the alumina ceramic board.(12.5x20x0.7mm)

Not recommended  
for new design

Package Dimensions

As of January, 2001

Unit: mm



Hitachi Code	CMPAK
JEDEC	—
EIAJ	Conforms
Mass (reference value)	0.006 g

Not recommend  
for new design

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